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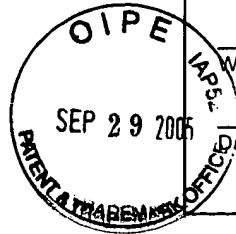
PATENT

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on September 27, 2005.

William R. Allen

William R. Allen, Reg. No. 48,389

27 September 2005



Applicant: David Fairbourn  
Serial No: 10/613,620  
Filing Date: July 3, 2003  
Art Unit: 1763  
Examiner: Jeffrie Robert Lund  
Title: SIMPLE CHEMICAL VAPOR DEPOSITION SYSTEM AND METHODS FOR DEPOSITING MULTIPLE-METAL ALUMINIDE COATINGS  
Confirmation No.: 4378  
Attorney Docket: MTCL-09

Cincinnati, Ohio 45202

September 27, 2005

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In accordance with the duty of candor and good faith imposed by 37 C.F.R. §1.56, and means of complying therewith according to 37 C.F.R. §§1.97 and 1.98, the references listed on the attached Form PTO-1449 are called to the attention of the United States Patent and Trademark Office in connection with the above-identified patent application.

Applicant requests that the Examiner consider the cited references and make an independent evaluation of their materiality. Applicant has also enclosed a copy of the foreign search report listing these references. A copy of the foreign reference is enclosed.

**Certification under 37 C.F.R. § 1.704(d)**

The foreign patent office communication cited herein was not received by any individual designated in 1.56(c) more than thirty days prior to submission of this Supplemental Information Disclosure Statement.

**Certification under 37 C.F.R. § 1.97(e)**

Each item of information contained in the information disclosure statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the information disclosure statement.

Applicant does not believe that any fees are due in connection with this submission. However, if such petition is due or any fees are necessary, the Commissioner may consider this to be a request for such and charge any necessary fees to deposit account 23-3000.

Respectfully submitted,  
WOOD, HERRON & EVANS, L.L.P.

*William R. Allen*

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William R. Allen, Reg. No. 48,389

2700 Carew Tower  
441 Vine Street  
Cincinnati, OH 45202  
(513) 241-2324

SUBSTITUTE FORM PTO-1449 (MODIFIED)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY. DOCKET NO. MTCL/09	SERIAL NO. 10/613,620
INFORMATION DISCLOSURE STATEMENT BY APPLICANT				APPLICANT David Fairbourn	
				FILING DATE July 3, 2003	GROUP 1763
(37 CFR 1.98(b))		(Use several sheets if necessary)			

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL		PATENT NUMBER							ISSUE DATE	PATENTEE		CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	A.A	4 2 6 4 6 8 2							4/28/1981	Fuyama et al.		428	336	7/2/1979
	A.B	5 4 0 7 7 0 4							4/18/1995	Basta et al.		427	248.1	8/26/1993
	A.C	5 4 0 7 7 0 5							4/18/1995	Vakil		427	255	3/1/1993
	A.D													
	A.E													
	A.F													
	A.G													
	A.H													
	A.I													
	A.J													
	A.K													

## FOREIGN PATENTS OR PUBLISHED FOREIGN PATENT APPLICATIONS

		DOCUMENT NUMBER	PUBLICATION DATE	COUNTRY OR PATENT OFFICE	CLASS	SUBCLASS	TRANSLATION (YES/NO)
	A.L	55-058365	5/1/1980	JP	C23C 11/08		Abstract Only
	A.M						
	A.N						
	A.O						
	A.P						
	A.Q						

## OTHER DOCUMENTS (Including Author, Title, Date, Place of Publication)

A.R	Derderian et al., <u>United States Patent Application Publication No. US 2003/0032283</u> , Publication Date: 2/13/2003
A.S	Warnes et al., <u>United States Patent Application Publication No. US 2003/0049374</u> , Publication Date: 3/13/2003
A.T	

EXAMINER	DATE CONSIDERED
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EXAMINER: Initial if citation considered, whether or not in conformance. Draw line through citation only if not in conformance and not considered. Include a copy of this form with next communication to applicant.